- Precision Negative Series Pass Voltage Regulation
- 0.2 V Dropout at 0.5 A
- Wide Input Voltage Range –3.2 V to –15 V
- Low Quiescent Current Irrespective of Load
- Simple Logic Shutdown Interfacing
- −5 V, −12 V, and Adjustable Output
- 2.5% Duty Cycle Short Circuit Protection

VOUTS 1 8 SD/CT VIN 2 7 VIN VIN 3 6 VIN GND 4 5 VOUT

description

The UCC384-x family of negative linear-series pass regulators is tailored for low-dropout applications where low-quiescent power is important. Fabricated with a BCDMOS technology ideally suited for low input-to-output differential applications, the UCC384-x passes 0.5 A while requiring only 0.2 V of input-voltage headroom. Dropout voltage decreases linearly with output current, so that dropout at 50 mA is less than 20 mV.

Quiescent current consumption for the device under normal (non-dropout) conditions is typically 200 μ A. An integrated charge pump is internally enabled only when the device is operating near dropout with low VIN. This ensured that the device meets the dropout specifications even for maximum load current and a VIN of -3.2 V with only a modest increase in quiescent current. Quiescent current is always less than 350 μ A, with the charge pump enabled. The quiescent current of the UCC384 does not increase with load current.

Short-circuit current is internally limited. The device responds to a sustained overcurrent condition by turning off after a t_{ON} delay. The device then stays off for a period, t_{OFF} , that is 40 times the t_{ON} delay. The device then begins pulsing on and off at the t_{ON}/t_{OFF} duty cycle of 2.5%. This drastically reduces the power dissipation during short circuit such that heat sinking, if at all required, must only accommodate normal operation. An external capacitor sets the on time. The off time is always 40 times t_{ON} .

The UCCx84-x can be shutdown to 45 μ A (maximum) by pulling the SD/CT pin more positive than -0.7 V. To allow for simpler interfacing, the SD/CT pin may be pulled up to 6 V above the ground pin without turning on clamping diodes.

Internal power dissipation is further controlled with thermal-overload protection circuitry. Thermal shutdown occurs if the junction temperature exceeds 140° C. The chip remains off until the temperature has dropped 20° C ($T_{\perp} = 120^{\circ}$ C).

AVAILABLE OPTIONS

т.	OUTPUT VOLTAGE (V)	PACKAGE DEVICES			
TA	TYP	(SOIC) DP			
	-5	UCC284DP-5			
-40°C to 85°C	-12	UCC284DP-12			
	ADJ	UCC284DP-ADJ			
	-5	UCC384DP-5			
0°C to 70°C	-12	UCC384DP-12			
	ADJ	UCC384DP-ADJ			

[†] All package types are available taped and reeled. Add TR suffix to device type (e.g. UCC284DP–5TR) to order quantities of 3000 devices per reel.



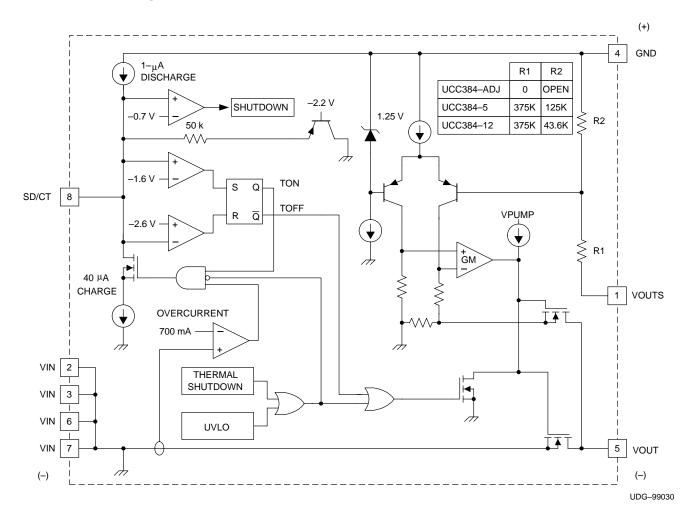
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



UCC284-5, UCC284-12, UCC284-ADJ, UCC384-5, UCC384-12, UCC384-ADJ LOW-DROPOUT 0.5-A NEGATIVE LINEAR REGULATOR

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functional block diagram



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†‡

Input voltage range [‡] , V _{IN}	16 V
Shutdown voltage range, SD/CT	–5 V to 6 V
Operating virtual junction temperature range, T _J	
Storage temperature range T _{stg}	. −65°C to 150°C
Lead temperature (Soldering, 10 seconds)	300°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



[‡] All voltages are with respect to ground. Currents are positive into and negative out of the specified terminals.

electrical characteristics T_A = 0°C to 70°C for the UCC384 and –40°C to 85°C for the UCC284, VIN = VOUT – 1.5 V, I_{OUT} = 0 mA, C_{OUT} = 4.7 $\mu\text{F},$ and CT = 0.015 $\mu\text{F}.$ For UCC384–ADJ, VOUT is set to –3.3V (unless otherwise noted)

PARAMETER	TES	T CONDITIONS	MIN	TYP	MAX	UNIT
UCC384-5 Fixed -5-V 0.5-A Regulation Section	n		•			
Output walks as	$T_A = 25^{\circ}C$		-5.075	- 5	-4.925	V
Output voltage	Over all conditions		-5.100		-4.850	V
Line regulation	VIN = −5.2 V to −1	5 V		1.5	10	mV
Load regulation	I _{OUT} = 0 mA to 0.5	5 A		0.1	0.25	%
Output noise voltage	T _A = 25°C,	BW = 10 Hz to 10 kHz		200		μVRMS
Description (Color Miles	I _{OUT} 0.5 A,	VOUT = -4.8 V		0.20	0.50	V
Dropout voltage, VOUT – VIN	I _{OUT} 50 mA,	VOUT = -4.8 V		20	50	mV
UCC384-5 Fixed -5-V 0.5-A Power Supply Sec	ction					
Input voltage range			-15		-5.2	V
Quiescent current charge pump on	VIN = -4.85 V,	See Note 1		280	350	μΑ
Quiescent current	VIN = −15 V			200	250	μΑ
	VIN = -13 V , T _A = 0°C to 85°C,	SD/CT = 0 V See Note 2		15	45	μΑ
Quiescent current in shutdown	VIN = -13 V, $T_A = -40^{\circ}\text{C to } 0^{\circ}\text{C}$	SD/CT = 0 V			100	μΑ
Shutdown threshold	At shutdown pin (S		-1.0	-0.7	-0.4	V
Shutdown input current	SD/CT = 0 V	•	5	10	25	μΑ
Output leakage in shutdown	VIN = -15 V, See Note 3	VOUT = 0 V,		1	50	μΑ
Overtemperature shutdown				140		°C
Overtemperature hysteresis				20		°C
UCC384-5 Fixed -5-V 0.5-A Current Limit Sec	tion		L			
Peak current limit	VOUT = 0 V		0.7	1.1	1.5	Α
Overcurrent threshold			0.55	0.7	0.9	Α
Current limit duty cycle	VOUT = 0 V			2.5	4	%
Overcurrent time out, toN	VOUT = 0 V		300	500	700	μs
UCC384-12 Fixed 12-V 0.5-A Regulation Secti	on		· ·			
0	T _A = 25°C		-12.18	-12	-11.82	V
Output voltage	Over all conditions		-12.24		-11.64	V
Line regulation	VIN = -12.5 V to -	15 V		5	15	mV
Load regulation	I _{OUT} = 0 mA to 0.5	A		0.1	0.3	%
Output noise voltage	T _A = 25°C	BW = 10 Hz to 10 kHz		200		μVRMS
Description VOLT	I _{OUT} 0.5 A,	VOUT = −11.6 V		0.15	0.5	V
Dropout voltage, VOUT – VIN	IOUT 50 mA,	VOUT = -11.6 V		15	50	mV
UCC384-12 Fixed -12 V-0.5-A Power Supply S			•			-
Input voltage range			-15		-12.5	V
Quiescent current	VIN = −15 V			220	350	μΑ
Outcomet ourselt in about daying	VIN = -13 V, $T_A = 0^{\circ}\text{C to } 85^{\circ}\text{C},$	SD/CT = 0 V See Note 2		15	45	μΑ
Quiescent current in shutdown	VIN = -13 V, $T_A = -40^{\circ}\text{C to } 0^{\circ}\text{C}$	SD/CT = 0 V , See Note 2			100	μΑ

NOTES: 1. The internal charge pump is enabled only for dropout condition with low VIN. Only in this condition is the charge pump required to provide additional output FET fate drive to maintain dropout specifications. For conditions where the charge pump is not required, it is disabled, which lowers overall device power consumption.

^{3.} In the application during shutdown mode, output leakage current adds to quiescent current.



^{2.} Ensured by design. Not production tested.

UCC284-5, UCC284-12, UCC284-ADJ, UCC384-5, UCC384-12, UCC384-ADJ LOW-DROPOUT 0.5-A NEGATIVE LINEAR REGULATOR

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electrical characteristics $T_A=0^\circ C$ to $70^\circ C$ for the UCC384 and $-40^\circ C$ to $85^\circ C$ for the UCC284, VIN = VOUT - 1.5 V, $I_{OUT}=0$ mA, $C_{OUT}=4.7~\mu F,$ and CT = 0.015 $\mu F.$ For UCC384–ADJ, VOUT is set to -3.3 V (unless otherwise noted)

Output leakage in shutdown VIN = −15 V, See Note 3 VOUT = 0 V, See Note 3 1 50 μA Overtemperature shutdown 140 °C	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Shutdown input current	UCC384-12 Fixed -12 V-0.5-A Power Supply	Section (continued)	•			
Output leakage in shutdown VIN = −15 V, See Note 3 VOUT = 0 V, See Note 3 1 50 μA Overtemperature shutdown 140 °C	Shutdown threshold	At shutdown pin (SD/CT)	-1.0	-0.7	-0.4	V
Output leakage in shutdown See Note 3	Shutdown input current	SD/CT = 0 V	5	10	25	μΑ
Overtemperature hysteresis 20 °C UCC384-12 Fixed -12-V 0.5-A Current Limit Section VOUT = 0 V 0.7 1.1 1.5 A Overcurrent timeit VOUT = 0 V 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 30 50 70 μ Overcurrent time out, toN VOUT = 0 V 30 50 700 μ WCC384-ADJ Adjustable 0.5-A Regulation Section TA = 25°C -1.27 -1.25 -1.23 V Line regulation VIN = -3.5 V to -15 V, VOUT = VOUTS 0.5 3 mV Load regulation IouT = 0 mA to 0.5 A 0.1 0.18 % Output noise voltage BW = 10 Hz to 10 kHz, TA = 25°C 200 μ/VRMS Dropout voltage, VOUT – VIN IouT 50 mA, VOUT = -3.15 V 0.25 0.5 V Dropout voltage, VOUT and to 10 kHz, TA = 25°C 200 μ/VRMS 25 50 mV Sense pin input current 10UT 50 mA, VOUT = -3.15 V 0.25 0.5 V Underscent current charge pu	Output leakage in shutdown			1	50	μΑ
VOUT = 0 V	Overtemperature shutdown			140		°C
Peak current limit	Overtemperature hysteresis			20		°C
Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 300 500 700 μs Overcurrent time out, toN VOUT = 0 V 300 500 700 μs Cover temperature 300 500 700 μs Ta = 25°C -1.27 -1.25 -1.23 V Vertemperature -1.27 -1.25 -1.215 V Line regulation VIN = -3.5 V to -15 V, VOUT = VOUTS 0.5 3 mV Load regulation IQUT = 0 mA to 0.5 A 0.1 0.18 % Output noise voltage BW = 10 Hz to 10 kHz, Ta = 25°C 200 μνRMS Dropout voltage, VOUT - VIN IQUT 0.5 A, VOUT = -3.15 V 0.25 0.5 V Location in put current 100 250 mV UCC384-ADJ Adjustable 0.5-A Power Supply Section Imput voltage range -15 -35 V Undervoltage lockout -3.2 -2.95	UCC384-12 Fixed -12-V 0.5-A Current Limit	Section				
Current limit duty cycle VOUT = 0 V 2.5 4 % Overcurrent time out, t _{ON} VOUT = 0 V 300 500 700 μs UCC384-ADJ Adjustable 0.5-A Regulation Section Reference voltage TA = 25°C -1.27 -1.25 -1.215 V Line regulation VIN = -3.5 V to -15 V, VOUT = VOUTS 0.5 3 mV Load regulation I _{QUT} = 0 m A to 0.5 A 0.1 0.18 % Output noise voltage BW = 10 Hz to 10 kHz, TA = 25°C 200 µVRMS Output noise voltage, VOUT - VIN I _{QUT} 5.5 A, VOUT = -3.15 V 0.25 0.5 V Dropout voltage, VOUT - VIN I _{QUT} 5.6 M, VOUT = -3.15 V 0.25 0.5 V Bense pin input current 100 250 nA UCC384-ADJ Adjustable 0.5-A Power Supply Section 100 250 nA UCC384-ADJ Adjustable 0.5-A Power Supply Section -3.2 -2.95 -2.7 V Underscent current charge pump on VIN = -3.15 V, SDICT = 0 V 20 350 µA	Peak current limit	VOUT = 0 V	0.7	1.1	1.5	Α
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Overcurrent threshold		0.55	0.7	0.9	Α
	Current limit duty cycle	VOUT = 0 V		2.5	4	%
TA = 25°C	Overcurrent time out, t _{ON}	VOUT = 0 V	300	500	700	μs
Over temperature	UCC384-ADJ Adjustable 0.5-A Regulation S	Section	-U			
Over temperature -1.2/5	B. ()	T _A = 25°C	-1.27	-1.25	-1.23	V
Load regulation	Reference voltage	Over temperature	-1.275		-1.215	V
Dutput noise voltage BW = 10 Hz to 10 kHz, T _A = 25°C 200 μVRMS	Line regulation	$VIN = -3.5 \text{ V to } -15 \text{ V}, \qquad VOUT = VOUTS$		0.5	3	mV
Dutput noise voltage BW = 10 Hz to 10 kHz, T _A = 25°C 200 μVRMS	Load regulation	I _{OUT} = 0 mA to 0.5 A		0.1	0.18	%
Dropout voltage, VOUT – VIN IQUT 50 mA, VOUT = -3.15 V 25 50 mV Sense pin input current 100 250 nA UCC384–ADJ Adjustable 0.5-A Power Supply Section Input voltage range -15 -3.5 V Undervoltage lockout -3.2 -2.95 -2.7 V Quiescent current charge pump on VIN = -3.15 V, See Note 1 200 350 μA Quiescent current VIN = -15 V 200 250 μA VIN = -13 V, SD/CT = 0 V TA = $^{\circ}$ C to 85°C, See Note 2 15 45 μA Shutdown threshold At shutdown pin (SD/CT) -1.0 -0.7 -0.4 V Shutdown input current SD/CT = 0V 5 10 25 μA Output leakage in shutdown VIN = -15V, See Note 3 VOUT = 0 V, See Note 3 1 50 μA Overtemperature shutdown 140 $^{\circ}$ C $^{\circ}$ C Overtemperature hysteresis 20 $^{\circ}$ C UCC384-ADJ Adjustable 0.5-A Current Limit Section 0.55 0.7 </td <td>Output noise voltage</td> <td></td> <td></td> <td>200</td> <td></td> <td>μVRMS</td>	Output noise voltage			200		μVRMS
OUT 50 mA, VOUT = -3.15 V 25 50 mV		I _{OUT} 0.5 A, VOUT = -3.15 V		0.25	0.5	V
Description Description	Dropout voltage, VOUT – VIN	I_{OUT} 50 mA, $VOUT = -3.15 \text{ V}$		25	50	mV
Input voltage range -15 -3.5 V Undervoltage lockout -3.2 -2.95 -2.7 V Quiescent current charge pump on VIN = -3.15 V, See Note 1 200 350 μA Quiescent current VIN = -15 V 200 250 μA VIN = -13 V, TA = 0°C to 85°C, See Note 2 15 45 μA Quiescent current in shutdown ND/CT = 0 V 100 μA Shutdown threshold At shutdown pin (SD/CT) -1.0 -0.7 -0.4 V Shutdown input current SD/CT = 0V 5 10 25 μA Output leakage in shutdown VIN = -15V, See Note 3 VOUT = 0 V, See Note 3 1 50 μA Overtemperature shutdown 140 °C Overtemperature hysteresis 20 °C UCC384-ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cy	Sense pin input current			100	250	nA
Undervoltage lockout	UCC384-ADJ Adjustable 0.5-A Power Supp	ly Section	•			
Quiescent current charge pump onVIN = -3.15 V,See Note 1200 350 μA Quiescent currentVIN = -15 V 200 250 μA Quiescent current in shutdown $VIN = -13$ V, VI	Input voltage range		-15		-3.5	V
	Undervoltage lockout		-3.2	-2.95	-2.7	V
Quiescent current in shutdown	Quiescent current charge pump on	VIN = -3.15 V, See Note 1		200	350	μΑ
Quiescent current in shutdown	Quiescent current	VIN = -15 V		200	250	μΑ
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Quiagoost current in abutdown	- ,		15	45	μА
Shutdown input current SD/CT = 0V 5 10 25 μ A Output leakage in shutdown VIN = -15V, See Note 3 VOUT = 0 V, See Note 3 1 50 μ A Overtemperature shutdown 140 °C Overtemperature hysteresis 20 °C UCC384-ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Quiescent current in strutdown				100	μΑ
Output leakage in shutdown VIN = -15V, See Note 3 VOUT = 0 V, See Note 3 1 50 μA Overtemperature shutdown 140 °C Overtemperature hysteresis 20 °C UCC384-ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Shutdown threshold	At shutdown pin (SD/CT)	-1.0	-0.7	-0.4	V
Output leakage in shutdown See Note 3 1 50 μA Overtemperature shutdown 140 °C Overtemperature hysteresis 20 °C UCC384-ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Shutdown input current	SD/CT = 0V	5	10	25	μΑ
Overtemperature hysteresis 20 °C UCC384–ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Output leakage in shutdown	- , ,		1	50	μΑ
UCC384-ADJ Adjustable 0.5-A Current Limit Section Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Overtemperature shutdown			140		°C
Peak current limit VOUT = 0 V 0.7 1.1 1.5 A Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	Overtemperature hysteresis			20		°C
Overcurrent threshold 0.55 0.7 0.9 A Current limit duty cycle VOUT = 0 V 2.5 4 %	UCC384-ADJ Adjustable 0.5-A Current Limi	t Section				
Current limit duty cycle VOUT = 0 V 2.5 4 %	Peak current limit	VOUT = 0 V	0.7	1.1	1.5	Α
	Overcurrent threshold		0.55	0.7	0.9	Α
Overcurrent time out, t _{ON} VOUT = 0 V 300 500 700 μs	Current limit duty cycle	VOUT = 0 V		2.5	4	%
	Overcurrent time out, tON	VOUT = 0 V	300	500	700	μs

- NOTES: 1. The internal charge pump is enabled only for dropout condition with low VIN. Only in this condition is the charge pump required to provide additional output FET fate drive to maintain dropout specifications. For conditions where the charge pump is not required, it is disabled, which lowers overall device power consumption.
 - 2. Ensured by design. Not production tested.
 - 3. In the application during shutdown mode, output leakage current adds to quiescent current.



UCC284-5, UCC284-12, UCC284-ADJ, UCC384-5, UCC384-12, UCC384-ADJ LOW-DROPOUT 0.5-A NEGATIVE LINEAR REGULATOR

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pin descriptions

GND: This is the low noise ground reference input. All voltages are measured with respect to the GND pin.

SD/CT: This is the shutdown pin and also the short-circuit timing pin. Pulling this pin more positive than -0.7 V puts the circuit in a low-current shutdown mode. Placing a timing capacitor between this pin and GND sets the short-circuit charging time, t_{ON} during an overcurrent condition. During an overcurrent condition, the output pulses at approximately a 2.5% duty cycle.

NOTE:The CT capacitor must be connected between this pin and GND, not VIN, to assure that the SD/CT pin is not pulled significantly negative during power-up. This pin should not be externally driven more negative than –5 V or the device will be damaged.

VIN: This is the negative input supply. Bypass this pin to GND with at least 1 μF of low ESR or ESL capacitance.

VOUT: Regulated negative-output voltage. A single $4.7-\mu F$ capacitor should be connected between this pin and GND. Smaller value capacitors can be used for light loads, but this degrades the load-step performance of the regulator.

VOUTS: This is the feedback pin for sensing the output of the regulator. For the UCC384-5 and UCC384-12 versions, VOUTS can be connected directly to VOUT. If the load is placed at a considerable distance from the regulator, the VOUTS lead can be used as a Kelvin connection to minimize errors due to lead resistance. Connecting VOUTS at the load moves the resistance of the VOUT wire into the control loop of the regulator, thereby effectively canceling the IR drop associated with the load path.

APPLICATION INFORMATION

overview

The UCCx84-x family of **negative** low-dropout linear (LDO) regulators provides a regulated-output voltage for applications with up to 0.5 A of load current. The regulators feature a low-dropout voltage and short-circuit protection, making their use ideal for demanding applications requiring fault protection.

programming the output voltage on the UCC384

The UCC384-5 and UCC384-12 have output voltages that are fixed at -5 V and -12 V respectively. Connecting VOUTS to VOUT gives the proper output voltage with respect to ground.

The UCC384-ADJ can be programmed for any output voltage between -1.25 V and -15 V. This is easily accomplished with the addition of an external resistor divider connected between GND and VOUT with VOUTS connected to the center tap of the divider. For an output of -1.25 V, no resistors are needed and VOUTS is connected directly to VOUT. The regulator-input voltage cannot be more positive than the UVLO threshold, or approximately -3 V. Thus, low dropout cannot be achieved when programming the output voltage more positive than approximately -3.3 V. A typical application circuit is shown in Figure 1.



APPLICATION INFORMATION

programming the output voltage on the UCC384 (continued)

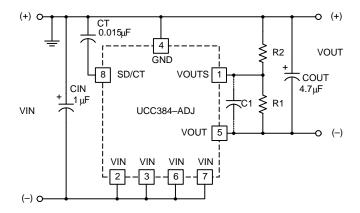


Figure 1. Typical Application Circuit

For the UCC384-ADJ, the output voltage is programmed by the following equation:

$$VOUT = -1.25 \times \left(1 + \frac{R1}{R2}\right) \tag{1}$$

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When R1 or R2 are selected to be greater than about 100 k Ω , a small ceramic capacitor should be placed across R1 to cancel the input pole created by R1 and the parasitic capacitance appearing on VOUTS. Values of approximately 20 pF should be adequate.

dropout performance

The UCC384 is tailored for low-dropout applications where low-quiescent power is important. Fabricated with a BCDMOS technology ideally suited for low input-to-output differential applications, the UCC384 passes 0.5 A while requiring only 0.2 V of headroom. The dropout voltage is dependent on operating conditions such as load current, input and load voltages, and temperature. The UCC384 achieves a low R_{DS}(on) through the use of an internal charge-pump that drives the MOSFET gate.

Figure 2 shows typical dropout voltages versus output voltage for the UCC384-5 V and -12 V versions as well as the UCC384–ADJ version programmed between –3.3 V and –15 V. Since the dropout voltage is also affected by output current, Figure 3 shows typical dropout voltages versus load current for different values of VOUT.

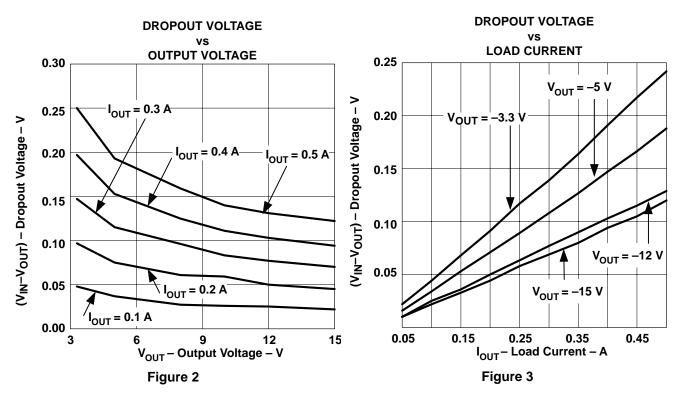
Operating temperatures also affect the R_{DS}(on) and the dropout voltage of the UCC384. Figure 4 shows typical dropout voltages for the UCC384 over temperature under a full load of 0.5 A.

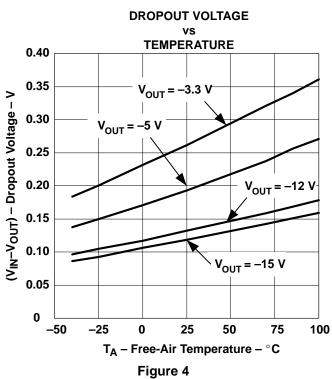
short-circuit protection

The UCC384 provides unique short-circuit protection circuitry that reduces power dissipation during a fault. When an overcurrent condition is detected, the device enters a pulsed mode of operation, limiting the output to a 2.5% duty cycle. This reduces the heat sink requirements during a fault. The operation of the UCC384 during an overcurrent condition is shown in Figure 5.



short-circuit protection (continued)





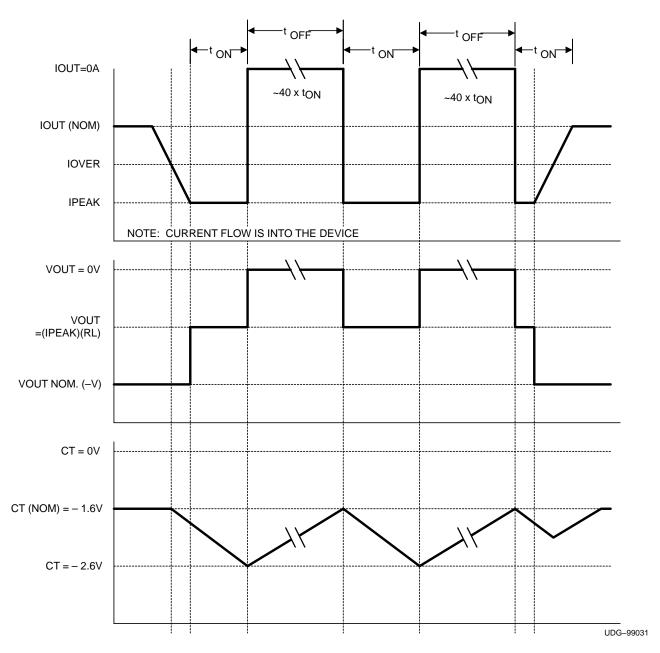


Figure 5. Short Circuit Timing

UCC384 short circuit timing

During normal operation the output voltage is in regulation and the SD/CT pin is held to -1.5~V via a $50\text{-}k\Omega$ internal-source impedance. If the output-current rises above the overcurrent threshold, the CT capacitor is charged by a $40\text{-}\mu\text{A}$ current sink. The voltage on the SD/CT pin moves in a negative direction with respect to GND.



UCC384 short-circuit timing (continued)

During an overcurrent condition, the regulator actively limits the maximum output current to the peak-current limit. This limits the output voltage of the regulator to:

$$V_{OUT} = I_{PEAK} \times R_{L} \tag{1}$$

If the output current stays above the overcurrent threshold, the voltage on the SD/CT pin reaches -2.6 V with respect to GND and the output turns off. The CT capacitor is then discharged by a 1- μ A current source. When the voltage on the SD/CT pin reaches -1.6 V with respect to GND, the output turns back on. This process repeats until the output current falls below the overcurrent threshold.

t_{ON}, the time the output is on during an overcurrent condition is determined by the following equation:

$$t_{ON} = CT (\mu F) \times \frac{1 \text{ V}}{40 \mu A} \text{seconds}$$
 (2)

tofe, the time the output is off during an overcurrent condition is determined by the following equation:

$$t_{OFF} = CT (\mu F) \times \frac{1 V}{1 \mu A}$$
 seconds (3)

capacitive loads

A capacitive load on the regulator's output appears as a short-circuit during start-up. If the capacitance is too large, the output voltage does not begin to regulate during the initial t_{ON} period and the UCC384 enters a pulsed mode operation. For a constant current load the maximum allowed output capacitance is calculated as follows:

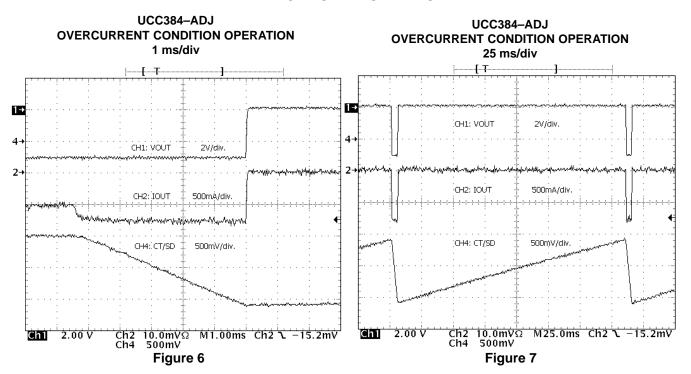
$$C_{OUT(max)} = \left[I_{PEAK}(A) - I_{LOAD}(A)\right] \times \frac{t_{ON}(sec)}{v_{OUT}(V)} \text{ Farads}$$
(4)

For worst case calculations, the minimum value for t_{ON} should be used, which is based on the value of CT capacitor selected. For a resistive load the maximum output capacitor can be estimated as follows:

$$C_{OUT(max)} = \frac{t_{ON}(sec)}{R_{LOAD}(\Omega) \times \ell n \left(\frac{1}{1 - \left(\frac{V_{OUT}(V)}{I_{MAX}(A) \times R_{LOAD}(\Omega)}\right)}\right)}$$
 Farads (5)

Figure 6 and Figure 7 are oscilloscope photos of the UCC384–ADJ operating during an overcurrent condition. Figure 6 shows operation of the circuit as the output current initially rises above the overcurrent threshold. This is shown on a 1ms/div. scale. Figure 7 shows operation of the same circuit on a 25 ms/div. scale showing one complete cycle of operation during an overcurrent condition.

APPLICATION INFORMATION



shutdown feature of the UCC384

The shutdown feature of the UCC384 allows the device to be placed in a low quiescent current mode. The UCC384 is shut down by pulling the SD/CT pin more positive than –0.7 V with respect to GND. Figure 8 shows how a shutdown circuit can be configured for the UCC384 using a standard transistor-transistor logic signal to control it.

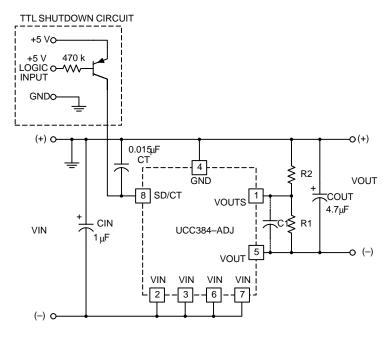


Figure 8. TTL Controlled Shutdown Circuit for the UCC384

UDG-99032



controlling the SD/CT pin

Forcing the SD/CT pin to any fixed voltage affects the operation of the circuit. As mentioned before, pulling the SD/CT pin more positive than -0.7 V puts the circuit in a shutdown mode, limiting the quiescent current to less than 45 μ A. Pulling this pin more positive than 6 V with respect to GND damages the device.

Forcing the SD/CT pin to any fixed voltage between $-0.7 \, \text{V}$ and $-1.6 \, \text{V}$ with respect to GND enables the output. However, in an overcurrent condition, the output does not pulse at a 2.5% duty cycle, but the output current is still limited to the peak current limit. This circuit may be used where a fixed current limit is needed, where a 2.5% duty cycle is undesirable. The UCC384 supplies a maximum current in this configuration as long as the temperature of the device does not exceed the overtemperature shutdown. This is determined by the peak current being supplied, the input and output voltages, and the type of heat sink being used. *Thermal design* is discussed later on in this data sheet.

Forcing the SD/CT pin to a voltage level between approximately –1.6 V and –2.6 V with respect to GND is not recommended as the output may or may not be enabled.

Forcing the SD/CT pin to a voltage level between approximately –2.6 V and –5 V with respect to GND turns the output off completely. The output remains off as long as the voltage is applied. Pulling this pin more negative than –5 V with respect to GND damages the device (see Table 1).

SD/CT STATE

6 V to -0.7 V Output disabled and device in low quiescent shutdown mode.

-0.7 V to -1.6 V Output enabled

-1.6 V to -2.6 V Output enabled or disabled depending on the previous state.

-2.6 V to -5 V Output disabled

Table 1 SD/CT Voltage Levels

VIN TO VOUT DELAY TIME DURING POWER-UP WITH CT = 0.22 μF

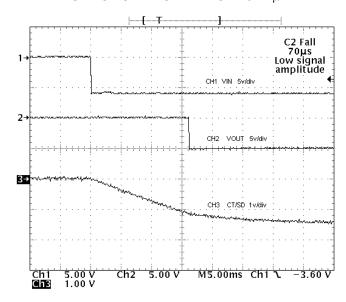


Figure 9

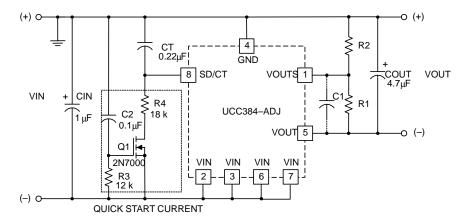
APPLICATION INFORMATION

VIN to VOUT Delay

During power-up there is a delay between VIN and VOUT. The majority of this delay time is due to the charging time of the CT capacitor. When VIN moves more negative than the UVLO of the device with respect to GND, the CT capacitor begins to charge. A 17- μ A current sink is used only during power up to charge the CT capacitor. When the voltage on the SD/CT pin reaches approximately –1.6 V with respect to GND, the output turns on and regulates. The larger the value of the CT capacitor, the greater the delay time between VIN and VOUT. Figure 9 shows the VIN to VOUT start-up delay, approximately 16 ms for a circuit with CT = 0.22 μ F.

Shorter delay times can be achieved with a smaller CT capacitor. The problem with a smaller CT capacitor is that with a very large load, the circuit may stay in overcurrent mode and never turn on. A circuit with a large capacitive load needs a large CT capacitor to operate properly.

One way to shorten the delay from VIN to VOUT during powerup, is with the use of the quick start-up circuit shown in Figure 10.

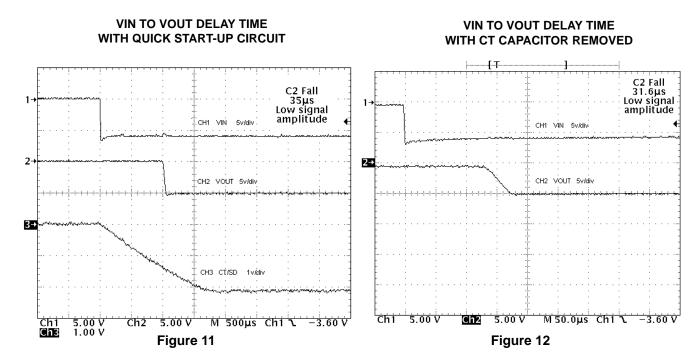


UDG-99033

Figure 10. Quick Start-Up Circuit for UCC384

With the quick start-up circuit, the delay time between VIN and VOUT during start-up can be reduced dramatically. Figure 11 shows that with the quick start-up circuit, the VIN to VOUT delay time has been reduced to approximately 1 ms.

VIN to VOUT Delay



operation of the quick start-up circuit

During normal start-up, the UCC384 does not turn on until the voltage on the SD/CT pin reaches approximately –1.6 V with respect to ground. It takes a certain amount of time for the CT capacitor to charge to this point. For a circuit that has a very large load, the CT capacitor needs to be large in order for the overcurrent timing to work properly. A large value of capacitance on the SD/CT pin increases the VIN to VOUT delay time.

The quick start-up circuit uses Q1 to quickly pull the SD/CT pin in a negative direction during start-up, thus decreasing the VIN-to-VOUT delay time. When VIN is applied to the circuit, Q1 turns on and starts to charge the CT capacitor. The current pulled through R4 determines the rate at which CT is charged. R4 can be calculated as follows:

$$R4 = \frac{V_{IN}(V) \times T_{D} \text{ seconds}}{1.6 \times CT (F)} \text{ ohms}$$
 (6)

t_D is the approximate VIN-to-VOUT delay time desired.

Q1 needs to be turned off after a fixed time to prevent the SD/CT pin from going too far negative with respect to GND. If the SD/CT pin is allowed to go too far negative with respect to GND, the output turns off again or possibly even damages the SD/CT pin. The maximum amount of time that Q1 should be allowed to be on is referred to as t_M and can be calculated as follows:

$$t_{M} = \frac{2.6}{1.6} \times t_{D} \text{ seconds} \tag{7}$$

R3 along with C2 set the time that Q1 is allowed to be on. Since t_M is the maximum amount of time that Q1 should be allowed to stay on, an added safety margin may be to use $0.9 \times t_M$ instead. This ensures that Q1 is turned off in the proper amount of time. With a chosen value for C2, R3 can be calculated as follows:

APPLICATION INFORMATION

operation of the quick start-up circuit (continued)

$$R3 = \frac{0.9 \times t_{M} \text{ seconds}}{C2(F) \times \ln \left(1 - \frac{V_{IN}(V) - 1.6}{V_{IN}(V)}\right)} \text{ Ohms}$$
(8)

After the CT capacitor has charged up for a time equal to $0.9 \times t_M$, Q1 turns off and allows the SD/CT pin to be pulled back to -1.5 V with respect to GND through a 50-k Ω resistor. At this point, the SD/CT pin can be used by the UCC384 overcurrent timing control.

minimum VIN to VOUT delay time

Although it may desirable to have as short a delay time as possible, a small portion of this delay time is fixed by the UCC384 and cannot be shortened. This is shown in Figure 12, where the CT capacitor has been removed from the circuit completely, giving a fixed VIN to VOUT delay of approximately 150 μ s for a circuit with VIN = -6 V and VOUT = -5 V.

thermal design

The *Packaging Information* section of the *Power Supply Control Products Data Book* (TI Literature No. SLUD003) contains reference material for the thermal ratings of various packages. The section also includes an excellent article entitled *Thermal Characteristics of Surface Mount Packages*, which is the basis for the following discussion.

Thermal design for the UCC384 includes two modes of operation, normal and pulsed. In normal mode, the linear regulator and heat sink must dissipate power equal to the maximum forward voltage drop multiplied by the maximum load current. Assuming a constant current load, the expected heat rise at the regulator's junction can be calculated as follows:

$$t_{RISE} = P_{DISS} \times (\theta jc + \theta ca)$$
 (9)

Theta (θ) is the thermal resistance and P_{DISS} is the power dissipated. The junction-to-case thermal resistance $(\theta | c)$ of the SOIC–8 DP package is 22°C/W. In order to prevent the regulator from going into thermal shutdown, the case-to-ambient thermal resistance (θca) must keep the junction temperature below 150°C. If the UCC384 is mounted on a 5 square inch pad of 1-ounce copper, for example, the thermal resistance $(\theta | ca)$ becomes 40–70°C/W. If a lower thermal resistance is required for the application, the device heat sinking needs to be improved.

When the UCC384 is in a pulsed mode, due to an overcurrent condition, the maximum average power dissipation is calculated as follows:

$$P_{avg} = \left[V_{IN}(V) - V_{OUT}(V)\right] \times I_{PEAK}(A) \times \left(\frac{t_{ON}(seconds)}{40 \times t_{ON}(seconds)}\right) Watts \tag{10}$$

As seen in equation (10), the average power during a fault is reduced dramatically by the duty cycle, allowing the heat sink to be sized for normal operation. Although the peak power in the regulator during the t_{ON} period can be significant, the thermal mass of the package normally keeps the junction temperature from rising unless the t_{ON} period is increased to several milliseconds.





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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
UCC284DP-12	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC284 DP-12 284-12	Samples
UCC284DP-5	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC284 DP-5 284-5	Samples
UCC284DP-5G4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC284 DP-5 284-5	Samples
UCC284DP-ADJ	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC284D P-ADJ 284-ADJ	Samples
UCC284DP-ADJG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC284D P-ADJ 284-ADJ	Samples
UCC284DPTR-5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC284 DP-5 284-5	Samples
UCC284DPTR-ADJ	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC284D P-ADJ 284-ADJ	Samples
UCC284DPTR-ADJG4	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC284D P-ADJ 284-ADJ	Samples
UCC384DP-12	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC384 DP-12 384-12	Samples
UCC384DP-5	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC384 DP-5 384-5	Samples
UCC384DP-ADJ	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC384D P-ADJ 384-ADJ	Samples
UCC384DP-ADJG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC384D P-ADJ	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
										384-ADJ	
UCC384DPTR-12	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC384 DP-12 384-12	Samples
UCC384DPTR-5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC384 DP-5 384-5	Samples
UCC384DPTR-ADJ	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR		UCC384D P-ADJ 384-ADJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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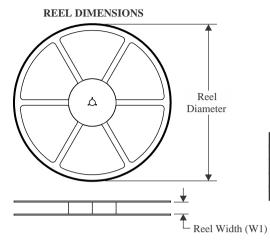
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

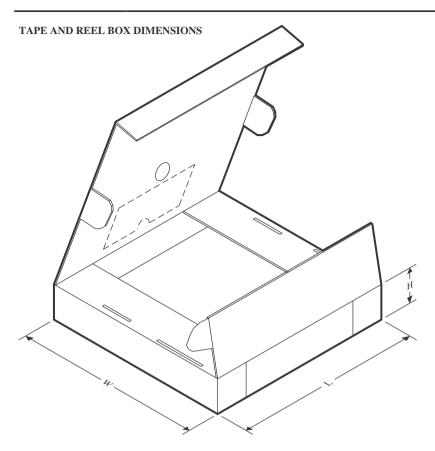


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UCC284DPTR-5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UCC284DPTR-ADJ	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UCC384DPTR-12	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UCC384DPTR-5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UCC384DPTR-ADJ	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1



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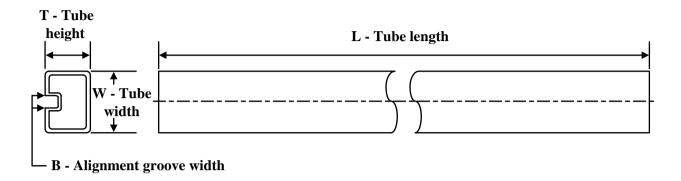
*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UCC284DPTR-5	SOIC	D	8	2500	356.0	356.0	35.0
UCC284DPTR-ADJ	SOIC	D	8	2500	356.0	356.0	35.0
UCC384DPTR-12	SOIC	D	8	2500	356.0	356.0	35.0
UCC384DPTR-5	SOIC	D	8	2500	356.0	356.0	35.0
UCC384DPTR-ADJ	SOIC	D	8	2500	356.0	356.0	35.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
UCC284DP-12	D	SOIC	8	75	506.6	8	3940	4.32
UCC284DP-5	D	SOIC	8	75	506.6	8	3940	4.32
UCC284DP-5G4	D	SOIC	8	75	506.6	8	3940	4.32
UCC284DP-ADJ	D	SOIC	8	75	506.6	8	3940	4.32
UCC284DP-ADJG4	D	SOIC	8	75	506.6	8	3940	4.32
UCC384DP-12	D	SOIC	8	75	506.6	8	3940	4.32
UCC384DP-5	D	SOIC	8	75	506.6	8	3940	4.32
UCC384DP-ADJ	D	SOIC	8	75	506.6	8	3940	4.32
UCC384DP-ADJG4	D	SOIC	8	75	506.6	8	3940	4.32



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



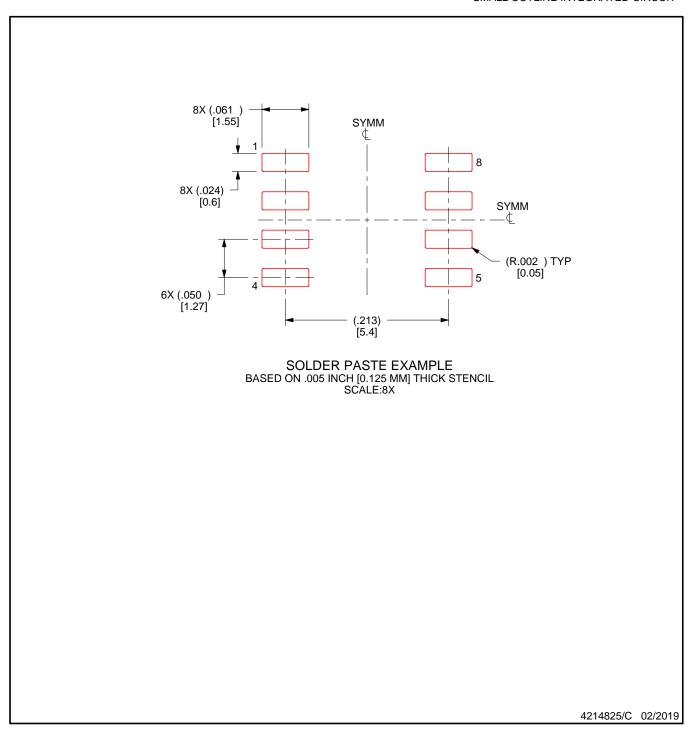
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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NCV8170BMX300TCG NCV8152MX300180TCG NCP700CMT45TBG AP7315-33W5-7 NCP154MX180300TAG AP2113AMTR-G1

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